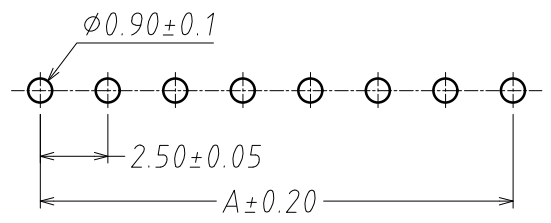
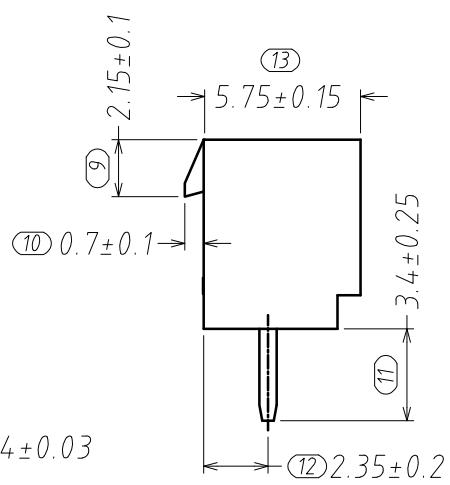
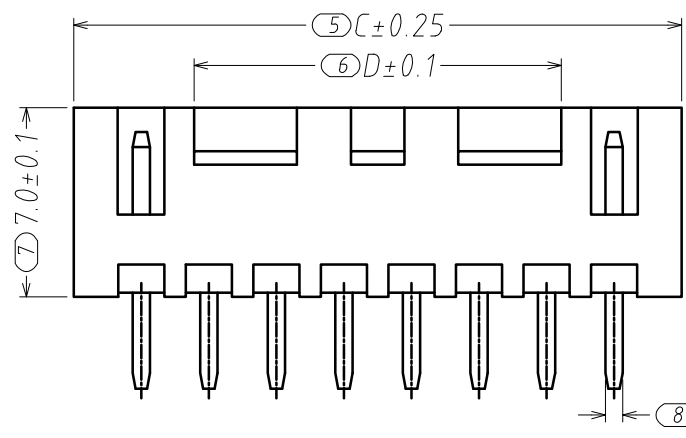
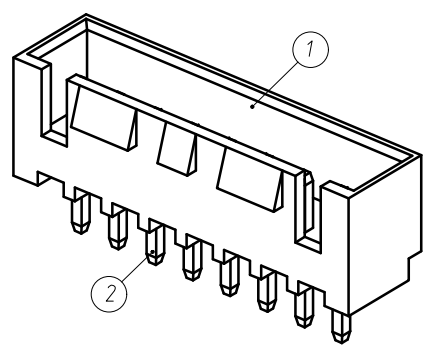
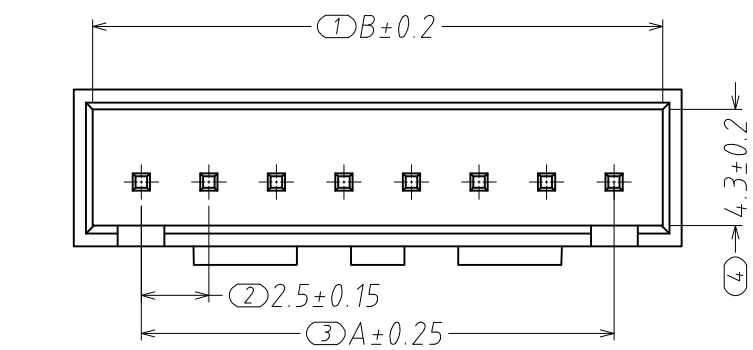


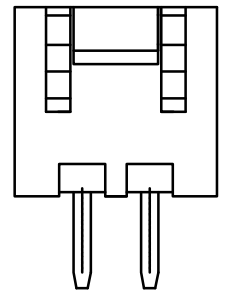
REV.	DESCRIPTION	DATE
A/0	初版发行	2013.10.13
B/0	升 B 版	2024.8.21

- 技术参数:
- 1、所有材料符合ROHS2.0/REACH要求。
 - 2、额定电流：3A，AC，DC；
 - 3、额定电压：250V，AC，DC；
 - 4、温度范围：-25℃~+85℃；
 - 5、接触电阻：≤0.02Ω；
 - 6、绝缘电阻：≥1000MΩ；
 - 7、耐压：1000V，AC/minute.
 - 8、产品料号：
A25002 - n A - 02 T1
孔位
产品类型
A:直插针座
电镀
T1:镀亮锡
胶芯材质
02:PA66 米色

Circuits	Dimensions (mm)			
	A	B	C	D
02	2.50	6.10	7.50	3.10
03	5.00	8.60	10.00	3.10
04	7.50	11.10	12.50	3.60
05	10.00	13.60	15.00	6.10
06	12.50	16.10	17.50	8.60
07	15.00	18.60	20.00	11.10
08	17.50	21.10	22.50	13.60
09	20.00	23.60	25.00	16.10
10	22.50	26.10	27.50	18.60
11	25.00	28.60	30.00	21.10
12	27.50	31.10	32.50	23.60
13	30.00	33.60	35.00	26.10
14	32.50	36.10	37.50	28.60
15	35.00	38.60	40.00	31.10
16	37.50	41.10	42.50	33.60



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)



2	端子 Contact	黄铜	n×1	电镀层: 整体镀层厚度30u"MIN,局部镀 80u"MIN.
1	基板 Wafer	PA66 (UL94V-0)	1	枪
序号	名称	材料	数量	附注

GENERAL TOLERANCES				DRAWN BY 罗荣程/2024.8.21		浙江深海电子有限公司	
0.X	±0.25	X.°	±3°	CHK. BY 朱江浩/2024.8.21			
0.XX	±0.12			APRV. BY 姚 婷/2024.8.21			
0.XXX	±0.05	X.X°	±0.5°			SHEET 1 OF 1	PROD. NAME SH-XHB2.54-NP-MS
UNIT	SIZE	SCALE		DRAWING NO. H25017-00		PART NO. A25002-nA-02T1	
MM	A4	1:1				TITLE 2.5mm pitch 180° WAFER-DIP TYPE	